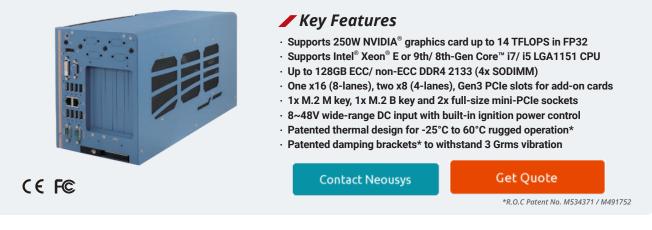


# Nuvo-8108GC

Industrial-grade Edge AI Platform Supporting 250W NVIDIA® Graphics Card, Intel® Xeon® E or 9th/ 8th-Gen Core™ Processor



### Introduction

Nuvo-8108GC is a rugged edge AI platform with industrial-grade design and in-vehicle features. Designed specifically to support a high-end 250W NVIDIA<sup>®</sup> graphics card, it offers tremendous GPU power up to 14 TFLOPS in FP32 for emerging GPU-accelerated edge computing, such as autonomous driving, vision inspection and surveillance/ security.

Nuvo-8108GC is powered by Intel<sup>®</sup> Xeon<sup>®</sup> E or 9th/ 8th-Gen Core<sup>™</sup> (up to 8-core/ 16-thread) CPUs coupled with workstation-grade Intel<sup>®</sup> C246 chipset to support up to 128 GB ECC or non-ECC DDR4 memory. The system incorporates an internal 2.5" HDD/ SSD tray and one hot-swappable 2.5" HDD/ SSD tray for easy replacement. There is also an M.2 2280 NVMe socket for the fast read/ write performance. Its front-accessible GbE and USB 3.1 Gen1/ Gen2 ports feature screw-lock mechanisms for securing cable connections. In addition to the x16 PCIe slot (8-lanes) for GPU installation, Nuvo-8108GC has other two x8 PCIe slots (4-lanes) and one x16 PCIe slot (8-lanes) for expansion cards to extend function sets like data collection, analytics and communication.

Nuvo-8108GC has a brand new power delivery design to accept 8~48V wide-range DC input and to handle heavy power requirements from 250W GPU. Along with built-in ignition control, it's feasible to deploy it on a vehicle and directly power it via the car's power system. Mechanical wise, Nuvo-8108GC incorporates Neousys' patented heat dissipation design\*, damping brackets\* and patent-pending GPU press bar, making it steady and rock-solid in various conditions. The Nuvo-8108GC is Neousys' response to the never-ending demand of TFLOPS in industrial GPU platforms. With industrial-grade power, thermal and mechanical design, it pushes versatile AI inference applications from laboratories to field applications, where reliability matters.

### Specifications

System Core		Expansion Bus	
_	Supporting Intel <sup>®</sup> Xeon <sup>®</sup> E and 9th/ 8th-Gen CPU (LGA1151 socket) - Xeon E 2176G/ 2278GE (8C/16T) / 2278GEL (8C/16T)	PCI Express	2x PCle x16 slot@Gen3, 8-lanes 2x PCle x8 slots@Gen3, 4-lanes
Processor	- i7-9700E, i7-9700TE, i7-8700, i7-8700T - i5-9500E, i5-9500TE, i5-8500, i5-8500T - i3-9100E, i3-9100TE, i3-8100, i3-8100T	M.2	1x M.2 2242 B key socket supporting dual SIM mode with selected M.2 LTE module
Chipset	Intel <sup>®</sup> C246 Platform Controller Hub	Mini-PCle	2x full-size mini PCI Express socket
Graphics	Independent GPU via x16 PEG port, or integrated Intel <sup>®</sup> UHD Graphics 630	Power Supply	2x 4-pin pluggable terminal block for 8~48V DC input
Memory	Up to 128 GB ECC/ non-ECC DDR4 2133 SDRAM (four SODIMM slots)	DC Input	with ignition control
AMT	Supports AMT 12.0	Dimension	170 mm (W) x 360 mm (D) x 198 mm (H)
TPM	Supports TPM 2.0	Weight	5 kg
I/O Interface		Mounting	Wall-mount with damping brackets
Ethernet	1x Gigabit Ethernet port by Intel <sup>®</sup> I219-LM 1x Gigabit Ethernet port by Intel <sup>®</sup> I210-IT	Environmental	
Video Port	1x VGA , supporting 1920 x 1200 resolution 1x DVI-D, supporting 1920 x 1200 resolution 1x DisplayPort, supporting 4096 x 2304 resolution	Operating Temperature       with 35W CPU and one NVIDIA* 250W GPU -25°C ~ 60°C ****         Storage Temperature       -25°C ~ 60°C */ ** (configured as 35W TDP mode) -25°C ~ 50°C */ ** (configured as 65W TDP mode)         Storage Temperature       -40°C ~ 85°C	
Serial Port	2x software-programmable RS-232/ 422/ 485 ports (COM1/		-25°C ~ 50°C */ ** (configured as 65W TDP mode)
	COM2) 4x USB 3.1 Gen2 (10 Gbps) ports		-40°C ~ 85°C
USB 3.1	4x USB 3.1 Gen1 (5 Gbps) ports 4x USB 3.1 Gen1 (5 Gbps) ports 1x USB 2.0 port (internal for dongle use)	Humidity	10%~90% , non-condensing
USB 2.0	1x USB 2.0 ports (internal for dongle use)	Vibration	Operating, MIL-STD-810G, Method 514.6, Category 4; and 3 Grms, 5-500 Hz, 3 Axes
Audio	1x 3.5 mm jack for mic-in and speaker-out		Operating, MIL-STD-810G, Method 516.6, Procedure I,
Storage Interface		Shock	Table 516.6-II
	1x hot-swappable HDD tray for 2.5" HDD/ SSD installation 1x Internal SATA port for 2.5" HDD/ SSD installation, supporting RAID 0/ 1	EMC	CE/ FCC Class A, according to EN 55024 & EN 55032
SATA		* For i7-9700E and i7-8700 running at 65W mode, the highest operating temperature shall be limited to 50°C an thermal throttling may occur when sustained full-loading applied. Users can configure CPU power in BIOS to obtain higher operating temperature. ** For sub-zero operating temperature, a wide temperature HDD or Solid State Disk (SSD) is required.	
M.2	1x M.2 2280 M key socket (PCle Gen3 x4) for NVMe SSD or Intel <sup>®</sup> Optane™ memory installation		
mSATA	2x full-size mSATA port (mux with mini-PCle)		



# Appearance Speaker -out DisplayPort x1 LED Indicators (HDD, WDT, UID, PWR) Ô DVI-D x1 & VGA x1 USB 3.1 Gen2 x2 USB 3.1 Gen1 x2 õooo GbE port x 2 USB 3.1 Gen2 x2 USB 3.1 Gen1 x2 0000 8-48V DC input P PCIEx4 COM1 & COM2 - Hot-swap HDD Dimensions Unit : mm 198 170 360

## **Ordering Information**

Model No.	Product Description
Nuvo-8108GC Industrial-grade edge AI platform supporting 250W NVIDIA® GPU Card, Intel® Xeon® E and 9th/ 8th-Gen Cor 8~48V wide-range DC input and built-in ignition control	

### **Optional Accessories**

PA-480W-DIN

480W AC-DC power Adapter(SDR-480-24) DIN-rail mount, 24V 20A, 90~264VAC/127~370VDC, Terminal Block, -20~+70°C, Meanwell SDR-480-24